XC25BS5 Series

ETR1502_002

PLL Clock Generator ICs with Built-In Divider/Multiplier Circuits (For Low Frequency Range)

■ GENERAL DESCRIPTION

The XC25BS5 series are high frequency, low power consumption PLL clock generator ICs with divider circuit & multiplier PLL circuit.

Laser trimming gives the option of being able to select from divider ratios (M) of 1,3 to 2047 and multiplier ratios (N) of 6 to 2047.

Output frequency (Q0) is equal to reference oscillation (fCLKin) multiplied by N/M, within a range of 3MHz to 30MHz. Q1 output is selectable from input reference frequency (f0), input reference frequency/2 (f0/2), ground (GND), and comparative frequency (f0/M). Further, comparative frequencies, within a range of 12KHz to 500KHz, can be obtained by dividing the reference oscillation. By halting operation via the CE pin, consumption current can be controlled and output will be one of high-impedance.

■APPLICATIONS

- Crystal oscillation modules
- Personal computers
- **●**PDAs
- Portable audio systems
- Various system clocks

■FEATURES

Output Frequency : 3MHz ~ 30MHz (Q0=fCLKin × N/M)

Input Frequency (fCLKin)

: 12kHz ~ 35MHz

Divider Ratio (M): Selectable from divisions of 1, 3~2047 **Multiplier Ratio (N)**: Selectable from multiplications of 6~2047

Output : 3-State

Q1 output selectable from input reference oscillation, input reference oscillation/2, GND, comparative frequency.

Operating Voltage Range

: 2.97V ~ 5.5V

Low Power Consumption

: CMOS (stand-by function included)*1

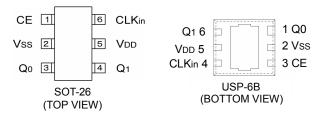
Comparative Frequency

: 12kHz~500kHz

Ultra Small Package: SOT-26, USP-6B

*1 High output impedance during standby

■PIN CONFIGURATION



*The dissipation pad for the USP-6B package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release.

If the pad needs to be connected to other pins, it should be connected to the \mbox{VdD} pin.

■PIN ASSIGNMENT

PIN NU	JMBER	PIN	FUNCTION
SOT-26	USP-6B	NAME	FUNCTION
1	3	CE	Chip Enable
2	2	Vss	GND
3	1	Q0	PLL Output
4	6	Q1	Reference Oscillation, Reference Oscillation/2, GND, or Comparative Frequency Output
5	5	VDD	Power Supply
6	4	CLKin	Reference Clock Input

■FUNCTION LIST

CE	FUNCTION					
"H"	Q0, Q1 Clock Output					
"L" Stand-by. Output Pin = High Impedance						
Open	Stand-by. Output Pin = High Impedance					
Open	(Vss Pin Pull-Down Due to IC's Internal Resistor)					

"H" = High level

"L" = Low level

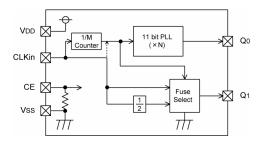
■PRODUCT CLASSIFICATION

Ordering Information

XC25BS5 12345

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
1 2 3	Product Number	Integer	: Based on internal standards e.g. Product number 001 → ①②③ = 001
4	Dookogo	М	: SOT-26
4	Package	D	: USP-6B
(5)	Dovice Orientation	R	: Embossed tape, standard feed
	Device Orientation	L	: Embossed tape, reverse feed

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER		SYMBOL	CONDITIONS	UNITS
Supply Voltage)	Vdd	Vss-0.3 ~ Vss+7.0	V
CLKin Pin Voltag	ge	Vcĸ	Vss-0.3 ~ VDD+0.3	V
CE Pin Voltage)	VCE	Vss-0.3 ~ VDD+0.3	V
Q0 Pin Voltage)	VQ0	Vss-0.3 ~ VDD+0.3	V
Q1 Pin Voltage	Q1 Pin Voltage		Vss-0.3 ~ VDD+0.3	V
Q0 Output Curre	nt	IQ0	±50	mA
Q0 Output Curre	nt	IQ1	±50	mA
Power Dissipation	SOT-26	Pd	150	mW
USP-6B		Fu	100	IIIVV
Operating Temperature Range		Topr	- 30 ~ + 80	°C
Storage Temperature	Range	Tstg	- 40 ~ +125	°C

■ FREQUENCY CONFIGURATION: EXAMPLE 1

XC25BS51XXMR

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS
Input Frequency	f CLKin	11.0000	-	16.9344	MHz
Multiplier/Divider Ratio	N/M	-	1.594	-	-
PLL Output Frequency	fQ0	17.5383	-	27.0000	MHz
Q1 Output Frequency	Q1		GND		-

Electrical Characteristics (DC)

XC25BS51xxMR

fCLKin = 16.9344MHz, Multiplier/Divider Ratio = 1.594, Ta = 25°C, No Load

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Voltage	Vdd		2.97	3.30	3.63	V
Input Voltage "High"	VIH		2.7	-	-	V
Input Voltage "Low"	VIL		-	-	0.6	V
Input Current "High"	ІІН	Vck = 3.3V	-	-	3.0	μΑ
Input Current "Low"	lıL	Vck = 0V	-3.0	-	-	μΑ
Output Voltage "High"	Vон	VDD = 2.97V, IOH = -8mA	2.5	-	-	V
Output Voltage "Low"	Vol	VDD = 2.97V, IOL = 8mA	-	-	0.4	٧
Supply Current 1	IDD1	CE = 3.3V	-	3.0	6.0	mA
Supply Current 2	IDD2	CE = 0V	-	-	5.0	μΑ
CE "High" Voltage	VCEH		2.7	-	-	٧
CE "Low" Voltage	VCEL		-	-	0.45	V
CE Pull-Down Resistance 1	Rp1	CE = 3.3V	0.5	1.5	2.5	МΩ
CE Pull-Down Resistance 2	Rp2	CE = 0.3V	20.0	50.0	80.0	kΩ

Electrical Characteristics (AC)

XC25BS51xxMR

fCLKin=16.9344MHz, Multiplier/Divider Ratio=1.594, Ta=25°C, CL=15pF

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Rise Time	TTLH	V _{DD} =3.3V(20% to 80%) (*1)	-	5.0	-	ns
Output Fall Time	TTHL	V _{DD} =3.3V(20% to 80%) (*1)	-	5.0	-	ns
Duty Ratio	DUTY		40	50	60	%
Output Start Time	Ton	(*1)	-	-	20	ms
PLL Output Jitter	Tj	1σ (*1)	-	40	-	ps

*1 R&D guarantee

■ FREQUENCY CONFIGURATION: EXAMPLE 2

XC25BS51XXMX

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS
Input Frequency	f CLKin	52.0000	-	78.0000	kHz
Multiplier/Divider Ratio	N/M	-	256.000	-	-
PLL Output Frequency	fQ0	13.312	-	19.968	MHz
Q1 Output Frequency	Q1		GND		-

●Electrical Characteristics (DC) XC25BS51xxMR

fCLKin=78kHz, Multiplier/Divider Ratio=256, Ta=25°C, No Load

SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Vdd		2.97	3.30	3.63	V
VIH		2.7	-	-	V
VIL		-	-	0.6	V
Iн	Vck=3.3V	-	-	3.0	μΑ
lıL	Vck=0V	-3.0	-	-	μΑ
Vон	VDD=2.97V, IOH= - 8mA	2.5	-	-	V
Vol	VDD=2.97V, IOL=8mA	-	-	0.4	V
IDD1	CE=0.3V	-	2.0	4.0	mA
IDD2	CE=0V	-	-	5.0	μΑ
VCEH		2.7	-	-	V
VCEL		-	-	0.45	V
Rp1	CE=3.3V	0.5	1.5	2.5	МΩ
Rp2	CE=0.3V	20.0	50.0	80.0	ΚΩ
	VDD VIH VIL IIH IIL VOH VOL IDD1 IDD2 VCEH VCEL Rp1	VDD VIH VIL IIH VCK=3.3V IIL VCK=0V VOH VDD=2.97V, IOH= - 8mA VOL VDD=2.97V, IOL=8mA IDD1 CE=0.3V IDD2 CE=0V VCEH VCEL Rp1 CE=3.3V	VDD 2.97 VIH 2.7 VIL - IIH VCK=3.3V - IIL VCK=0V -3.0 VOH VDD=2.97V, IOH= - 8mA 2.5 VOL VDD=2.97V, IOL=8mA - IDD1 CE=0.3V - IDD2 CE=0V - VCEH 2.7 VCEL - Rp1 CE=3.3V 0.5	VDD 2.97 3.30 VIH 2.7 - VIL - - IIH VCK=3.3V - - IIL VCK=0V -3.0 - VOH VDD=2.97V, IOH= - 8mA 2.5 - VOL VDD=2.97V, IOL=8mA - - IDD1 CE=0.3V - 2.0 IDD2 CE=0V - - VCEH 2.7 - VCEL - - Rp1 CE=3.3V 0.5 1.5	VDD 2.97 3.30 3.63 VIH 2.7 - - VIL - - 0.6 IIH VCK=3.3V - - 3.0 IIL VCK=0V -3.0 - - VOH VDD=2.97V, IOH= - 8mA 2.5 - - VOL VDD=2.97V, IOL=8mA - - 0.4 IDD1 CE=0.3V - 2.0 4.0 IDD2 CE=0V - - 5.0 VCEH 2.7 - - VCEL - - 0.45 Rp1 CE=3.3V 0.5 1.5 2.5

Electrical Characteristics (AC) XC25BS51xxMR

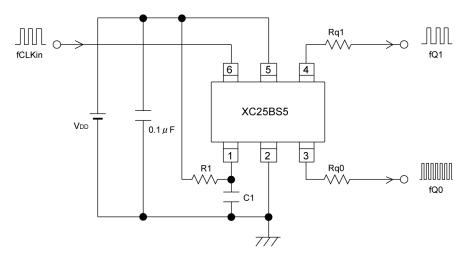
fCLKin=78kHz, Multiplier/Divider Ratio=256, Ta=25°C, CL=15pF

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Rise Time	TTLH	VDD=3.3V(20% to 80%) (*1)	-	5.0	-	ns
Output Fall Time	TTHL	VDD=3.3V(20% to 80%) (*1)	-	5.0	-	ns
Duty Ratio	DUTY		40	50	60	%
Output Start Time	Ton	(*1)	-	-	20	ms
PLL Output Jitter	Tj	1σ (*1)	-	20	-	ps

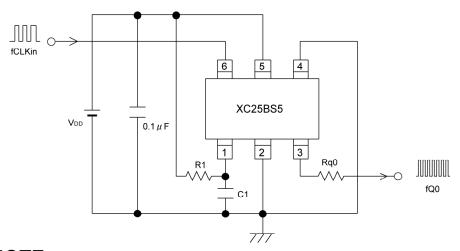
^{*1} R&D guarantee

■TYPICAL APPLICATION CIRCUITS

① Q1 Pin - reference oscillation, reference oscillation/2, comparative frequency



② Q1 Pin - GND

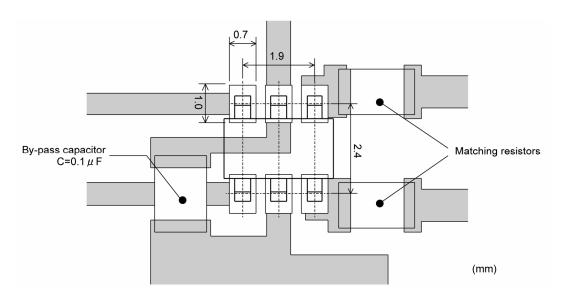


■ NOTE

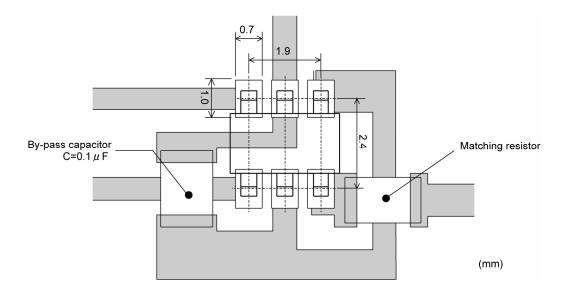
- (1) Please insert a by-pass capacitor of 0.1 μ F.
- (2) Rq0 and Rq1 are matching resistors. Their use is recommended in order to counter unwanted radiations.
- (3) Please place a by-pass capacitor and matching resistors as close to the IC as possible. It may be that the output cannot be locked if the by-pass capacitor is not close enough to the IC. Further, there is a possibility of unwanted radiation occurrence between the resistor and the IC pin if the matching resistor is not close enough to the IC.
- (4) When selecting GND for the Q1 pin, although the output of Q1 pin is GND level, it is also recommended that the Q1 pin be connected to GND pattern on the PCB.
- (5) When the CE pin is not controlled by external signals, it is recommended that a time constant circuit of R1=1k Ω × C1 = 0.1 μ F be added for stability.
- (6) With this IC, output is achieved by dividing and multiplying the reference oscillation by means of the PLL circuit. In cases where this output is further used as a reference oscillation of another PLL circuit, it may be that the final output signal's jitter increases, so all necessary precautions should be taken to avoid this.
- (7) It is recommended that a low noise power supply, such as a series regulator, be used for the supply voltage. Using a power supply such as a switching regulator might lead to a larger jitter, which in turn may lead to an inability to lock due to the ripple of the switching regulator.
- (8) As for this IC, synchronization of input and output signal's edge is not guaranteed though the input frequency operates to the output frequency multiply.

■ REFERENCE LAND PATTERN

① Q1 Pin - reference oscillation, reference oscillation/2, comparative frequency

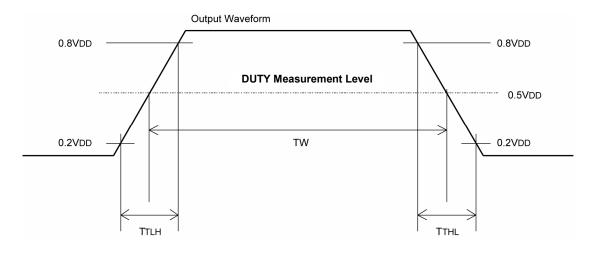


2 Q1 Pin - GND

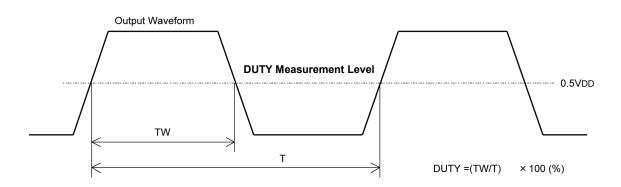


■AC CHARACTERISTIC WAVEFORMS

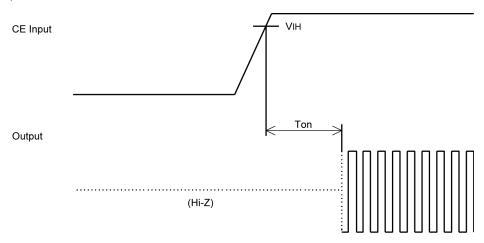
1) Output Rise Time / Output Fall Time



2) Duty Ratio



3) Output Start Time

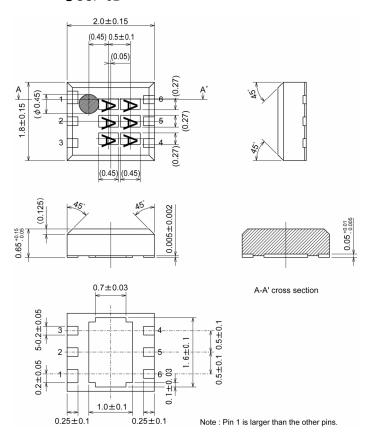


■PACKAGING INFORMATION

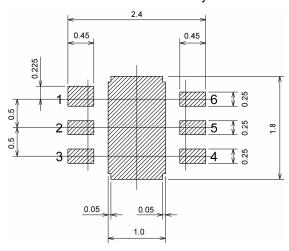
●SOT-26

0.4 *0.1 (0.5) (0.5) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95) (0.95)

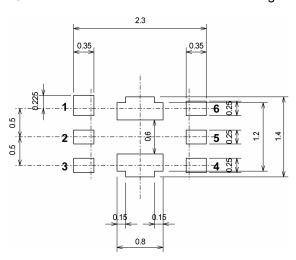
●USP-6B



●USP-6B Recommended Pattern Layout

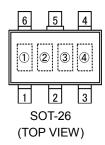


●USP-6B Recommended Metal Mask Design

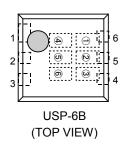


■ MARKING RULE

●SOT-26



●USP-6B



① Represents product series

MARK	PRODUCT SERIES
5	XC25BS51xxMx

23 Represents 2 and 3 of ordering information

Ī	MA	RK	PRODUCT SERIES
Ī	2	3	PRODUCT SERIES
ſ	0	7	XC25BS5107Mx

④ Represents assembly lot number (Based on internal standards)

①,②,③ Represents product series

MARK			PRODUCT SERIES
1	2	3	PRODUCT SERIES
В	S	0	XC25BS50xxDx
S	5	S	XC25BS5SxxDx

4,5 Represents 2 and 3 of ordering information (ex.)

MA	ARK	PRODUCT SERIES
4	5	
0	7	XC25BS5007Dx
0	1	XC25BS5S01Dx

⑥ Represents production lot number 0 to 9,A to Z repeated (G, I, J, O, Q, W excepted) Note: No character inversion used.

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